

**RESPONSE TO RESTRICTION REQUIREMENT AND PRELIMINARY AMENDMENT**

Serial Number: 10/612,764

Filing Date: June 30, 2003

Title: MOLD COMPOUND CAP IN A FLIP CHIP MULTI-MATRIX ARRAY PACKAGE AND PROCESS OF MAKING SAME

Assignee: Intel Corporation

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Dkt: 884.862US1

**REMARKS**

This responds to the Restriction Requirement mailed on December 2, 2004.

Claim 14 was amended, and claim 6 was non-elected. Claims 1-30 are currently pending in this application.

No new matter was added by this amendment. Support for the amendment comes from page 17, FIG. 19, and elsewhere from throughout the specification.

The Examiner is invited to telephone Applicant's attorney, John Greaves at (801) 278-9171, or Applicant's below-named representative at (612) 373-6970 to facilitate the prosecution of this application. If necessary, please charge any additional fees or credit overpayment to Deposit Account No. 19-0743.

Respectfully submitted,

VASSOUDEVANE LEBONHEUR ET AL.

By their Representatives,

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Date

January 3, 2005

By

Charles E. Steffey  
Charles E. Steffey  
Reg. No. 25,179

**CERTIFICATE UNDER 37 CFR 1.8:** The undersigned hereby certifies that this correspondence is being deposited with the United States Postal Service with sufficient postage as first class mail, in an envelope addressed to: MS Amendment, Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450 on this 3rd day of January 2005.

Name

Dennis Kempf

Signature

[Signature]